

Electronic Acknowledgement Receipt

EFS ID:	4247231
Application Number:	10549440
International Application Number:	
Confirmation Number:	5587
Title of Invention:	Copper alloy sputtering target process for producing the same and semiconductor element wiring
First Named Inventor/Applicant Name:	Takeo Okabe
Customer Number:	00270
Filer:	William Bak
Filer Authorized By:	
Attorney Docket Number:	OGOSH39USA
Receipt Date:	06-NOV-2008
Filing Date:	16-SEP-2005
Time Stamp:	17:59:04
Application Type:	U.S. National Stage under 35 USC 371

Payment information:

Submitted with Payment	yes
Payment Type	Deposit Account
Payment was successfully received in RAM	\$310
RAM confirmation Number	3413
Deposit Account	083040
Authorized User	

The Director of the USPTO is hereby authorized to charge indicated fees and credit any overpayment as follows:

Charge any Additional Fees required under 37 C.F.R. 1.492 (National application filing, search, and examination fees)

Charge any Additional Fees required under 37 C.F.R. Section 1.17 (Patent application and reexamination processing fees)

File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)
1		Amendment.pdf	681016 117e054c31723c54298f7f11d6a0319017c703	yes	16
Multipart Description/PDF files in .zip description					
Document Description		Start		End	
Amendment/Req. Reconsideration-After Non-Final Reject		1		1	
Claims		2		6	
Applicant Arguments/Remarks Made in an Amendment		7		15	
Extension of Time		16		16	

Warnings:**Information:**

2	Information Disclosure Statement (IDS) Filed (SB/08)	US_IDS_Form__SB_08a.pdf	608651 c35ba8be62769345038178115667c6f6c8e5e1	no	5
---	--	-------------------------	--	----	---

Warnings:**Information:**

3		FRefs1.pdf	1801406 6086077dd12bb67a7c388d146022d38ec d1ae95f	yes	28
Multipart Description/PDF files in .zip description					

Document Description	Start	End
Foreign Reference	1	5
Foreign Reference	6	12
Foreign Reference	13	17
Foreign Reference	18	22
Foreign Reference	23	28

Warnings:**Information:**

4		FRefs2.pdf	1568359 e99443d0052cd9196ec7bd7b162f5209e c95e	yes	26
---	--	------------	--	-----	----

Multipart Description/PDF files in .zip description					
	Document Description		Start	End	
	Foreign Reference		1	8	
	Foreign Reference		9	17	
	Foreign Reference		18	26	
Warnings:					
Information:					
5	Fee Worksheet (PTO-06)	fee-info.pdf	32027 42034dc33344d8c03cc06fe1de4d1a4f3a032e	no	2
Warnings:					
Information:					
Total Files Size (in bytes):				4691459	
<p>This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.</p> <p>New Applications Under 35 U.S.C. 111 If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p> <p>National Stage of an International Application under 35 U.S.C. 371 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p> <p>New International Application Filed with the USPTO as a Receiving Office If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.</p>					